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Docket No. M 11590 US

January 2, 2002

Box Patent Application
Commissioner For Patents
Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor(s): Nam, Shibaek, Jeon, Oseob; Heo, Chulho
Title: Semiconductor Device Having Multi-Chip Package Structure
X Return Receipt Postcard
X This Transmittal Letter (in duplicate)
11 page(s) Specification (not including claims)
8 page(s) Claims
1 page Abstract
4 Sheet(s) of Drawings (For Figs. 1, 2, 3, 4, 5 and 6)
2 page(s) Declaration For Patent Application and Power of Attorney
1 page(s) Recordation Form Cover Sheet (in duplicate)
2 page(s) Assignment

CLAIMS AS FILED

For	Number Filed	Number Extra	Rate	Basic Fee
Total Claims	60	40	\$18.00	\$ 740.00
Independent Claims	8	5	\$84.00	\$ 420.00
<input type="checkbox"/>	Fee of _____ for the first filing of one or more multiple dependent claims per application			\$
<input type="checkbox"/>	Fee for Request for Extension of Time			\$

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 1,880.00
☒ The Commissioner is hereby authorized to charge any additional fees which may be
required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:

EL 873075491 US

Respectfully submitted,

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J1046 U.S. PTO
10/038714
01/02/02